

Electronic Patent Application Fee Transmittal

Application Number:	10038264			
Filing Date:	03-Jan-2002			
Title of Invention:	Solder interconnect techniques			
First Named Inventor:	Seungbae Park			
Filer:	George McGuire/Ann Miller			
Attorney Docket Number:	EN999048D			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				790